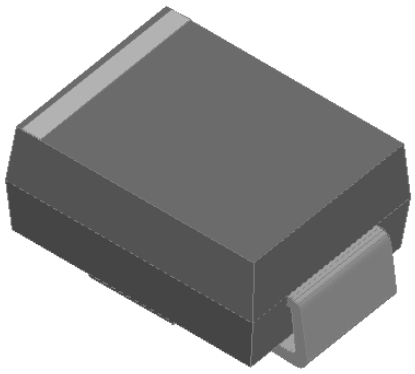
Surface Mount General Purpose Rectifier

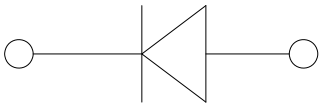


Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.



Mechanical Data

- **Package**: DO-214AA (SMB)
  Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end

■Maximum Ratings (Ta=25℃ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GS3AB	GS3BB	GS3DB	GS3GB	GS3JB	GS3KB	GS3MB
Device marking code			GS3AB	GS3BB	GS3DB	GS3GB	GS3JB	GS3KB	GS3MB
Maximum Repetitive peak reverse voltage	V_{RRM}	V	50	100	200	400	600	800	1000
Maximum RMS Voltage	V_{RMS}	V	35	70	140	280	420	560	700
Maximum DC Blocking Voltage	V_{DC}	V	50	100	200	400	600	800	1000
Average rectified output current @60Hz sine wave, resistance load, TL (Fig.1)	IO	A	3.0						
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25℃	I_{FSM}	A	100						
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25℃			200						
Current squared time @1ms≤t≤8.3ms Tj=25℃	I^2t	A^2s	41.5						
Storage temperature	Tstg	℃	-55 ~ +150						
Junction temperature	T_j	℃	-55 ~ +150						

■Electrical Characteristics (Ta=25℃ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GS3AB	GS3BB	GS3DB	GS3GB	GS3JB	GS3KB	GS3MB
Maximum instantaneous forward voltage	VF	V	IFM=3.0A	1.1						
Maximum DC reverse current at rated DC blocking voltage	IR	μA	T_j=25℃	5						
			T_j=125℃	100						
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	25						

■Thermal Characteristics （T_a=25℃ Unless otherwise specified）

PARAMETER	SYMBOL	UNIT	GS3AB	GS3BB	GS3DB	GS3GB	GS3JB	GS3KB	GS3MB
Typical Thermal Resistance	RθJ-A(1)	℃/W	65						
	RθJ-L(1)		22						
	RθJ-C(1)		18						

Note:
(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3" x 0.3" (8.0 mm x 8.0 mm) copper pad areas

■ Characteristics (Typical)

FIG.1: Io-TL Curve

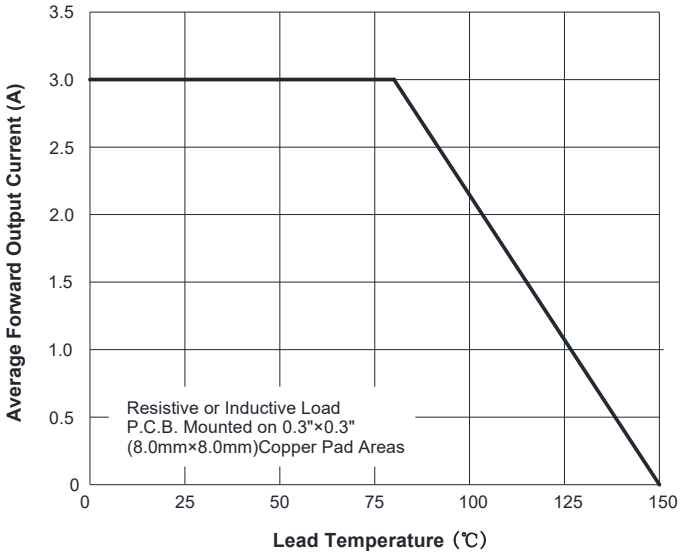


FIG.2: Forward Surge Current Capability

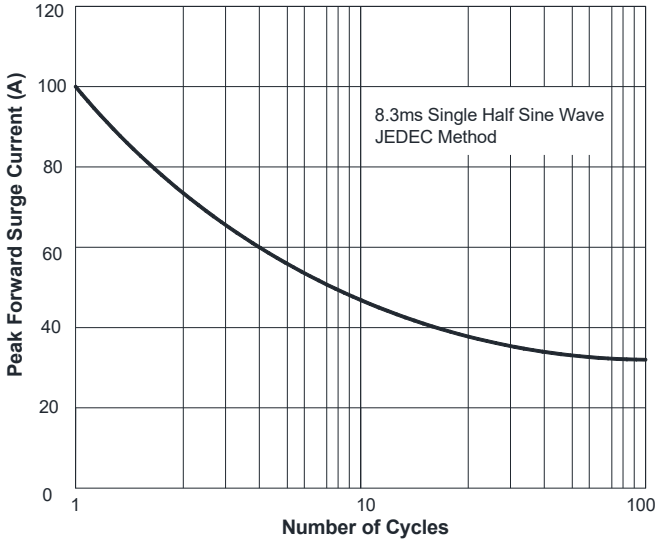


FIG.3: Typical Forward Voltage

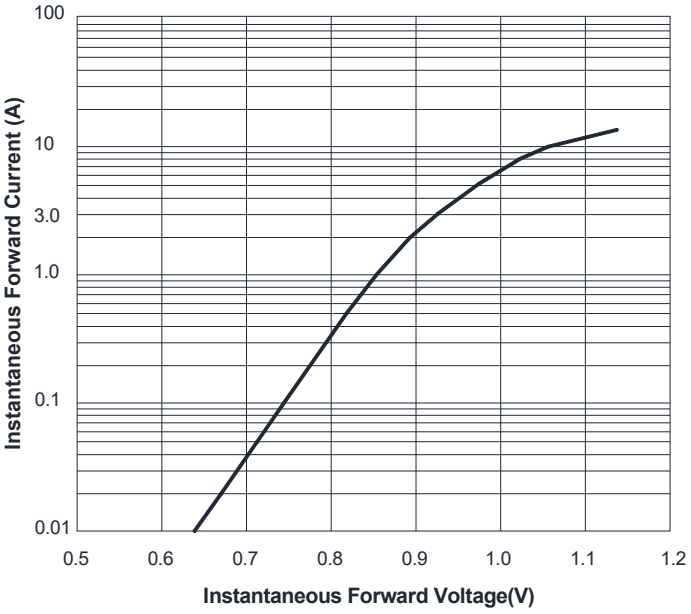
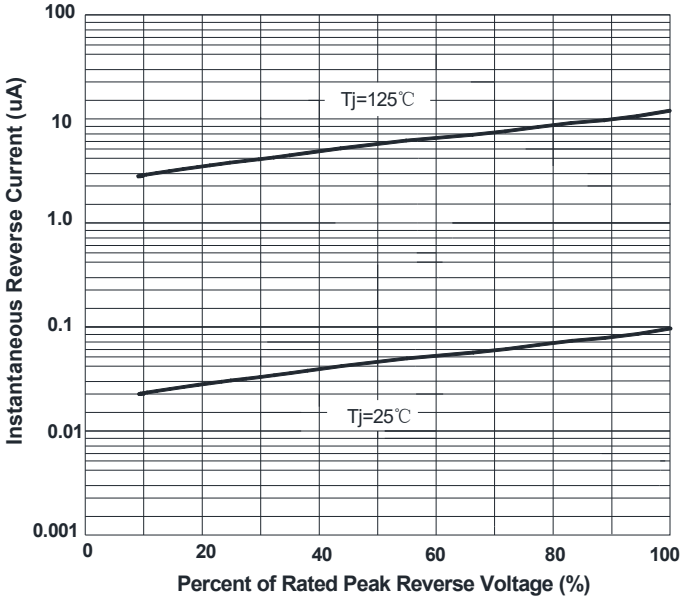


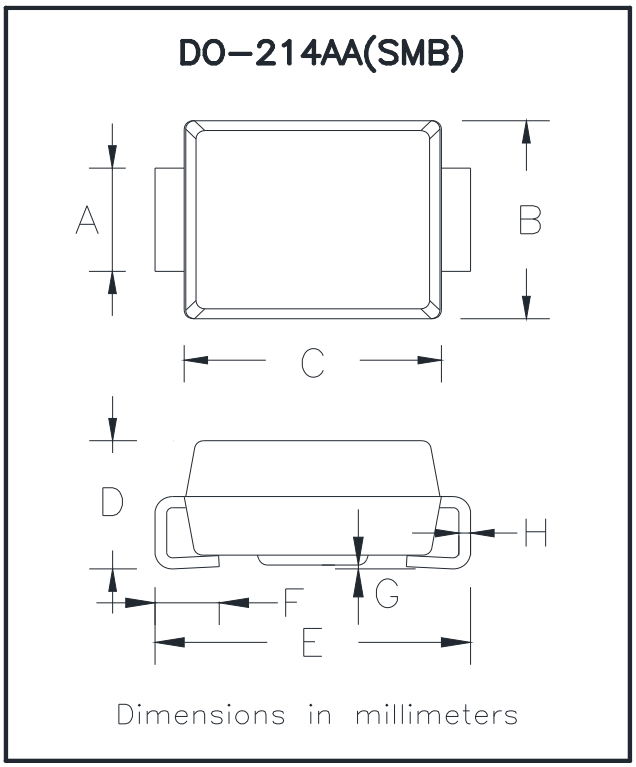
FIG.4: Typical Reverse Characteristics



■Ordering Information (Example)

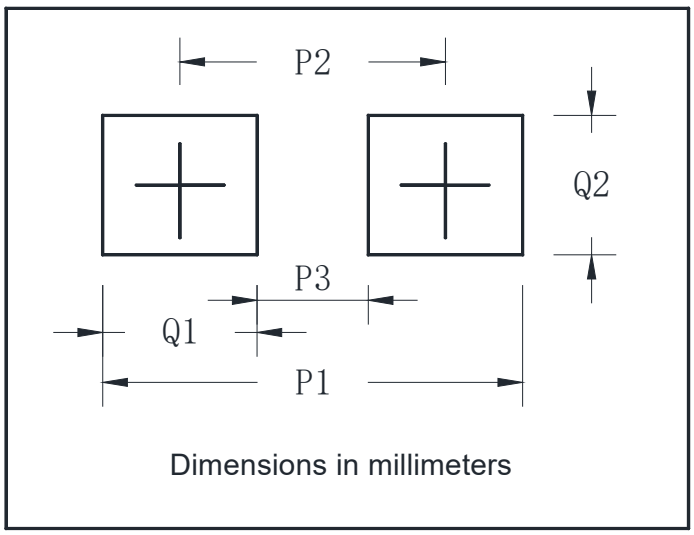
PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GS3AB-GS3MB	F1	Approximate 0.096	3000	/	48000	13” reel
GS3AB-GS3MB	F2	Approximate 0.096	750	6000	24000	7” reel
GS3AB-GS3MB	F3	Approximate 0.096	500	4000	16000	7” reel

■ Outline Dimensions



DO-214AA(SMB)		
Dim	Min	Max
A	1.85	2.15
B	3.30	3.94
C	4.05	4.75
D	1.99	2.61
E	5.21	5.59
F	0.90	1.41
G	0.05	0.20
H	0.15	0.31

■ Suggested pad layout



DO-214AA(SMB)	
Dim	Millimeters
P1	6.8
P2	4.3
P3	1.8
Q1	2.5
Q2	2.3

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